GREEN (5-2008)\*\*



**DESCRIPTION** 

visible and near infrared radiation.

### www.vishay.com

## Vishay Semiconductors

# Silicon PIN Photodiode

94 8390

# FEATURES

Package type: leadedPackage form: T-1¾

• Dimensions (in mm): Ø 5

· Leads with stand-off

• Radiant sensitive area (in mm<sup>2</sup>): 0.78

High photo sensitivity

· High radiant sensitivity

• Suitable for visible and near infrared radiation

• High bandwidth: 250 MHz at V<sub>R</sub> = 12 V

• Fast response times

• Angle of half sensitivity:  $\varphi = \pm 20^{\circ}$ 

 Compliant to RoHS Directive 2002/95/EC and in accordance with WEEE 2002/96/EC

#### Note

\*\* Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

### **APPLICATIONS**

· High speed photo detector

PRODUCT SUMMARY				
COMPONENT	I <sub>ra</sub> (μΑ)	φ (deg)	λ <sub>0.1</sub> (nm)	
BPV10	70	± 20	380 to 1100	

### Note

· Test condition see table "Basic Characteristics"

BPV10 is a PIN photodiode with high speed and high radiant

sensitivity in clear, T-134 plastic package. It is sensitive to

ORDERING INFORMATION				
ORDERING CODE	PACKAGING REMARKS		PACKAGE FORM	
BPV10	Bulk	MOQ: 4000 pcs, 4000 pcs/bulk	T-1¾	

#### Note

MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V <sub>R</sub>	60	V	
Power dissipation	T <sub>amb</sub> ≤ 25 °C	P <sub>V</sub>	215	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T <sub>amb</sub>	- 40 to + 100	°C	
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C	
Soldering temperature	t ≤ 5 s, 2 mm from body	T <sub>sd</sub>	260	°C	
Thermal resistance junction/ambient	Connected with Cu wire, 0.14 mm <sup>2</sup>	R <sub>thJA</sub>	350	K/W	



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PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 50 mA	$V_{F}$		1.0	1.3	V
Breakdown voltage	I <sub>R</sub> = 100 μA, E = 0	V <sub>(BR)</sub>	60			V
Reverse dark current	V <sub>R</sub> = 20 V, E = 0	I <sub>ro</sub>		1	5	nA
Diode capacitance	V <sub>R</sub> = 0 V, f = 1 MHz, E = 0	$C_D$		11		pF
	V <sub>R</sub> = 5 V, f = 1 MHz, E = 0	$C_D$		3.8		pF
Open circuit voltage	E <sub>A</sub> = 1 klx	Vo		480		mV
	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	Vo		450		mV
Short circuit current	E <sub>A</sub> = 1 klx	I <sub>K</sub>		80		μΑ
	$E_{e} = 1 \text{ mW/cm}^{2}, \lambda = 950 \text{ nm}$	I <sub>K</sub>		65		μΑ
Reverse light current	E <sub>A</sub> = 1 klx, V <sub>R</sub> = 5 V	I <sub>ra</sub>		85		μΑ
	$E_e = 1 \text{ mW/cm}^2,  \lambda = 950 \text{ nm},$ $V_R = 5 \text{ V}$	I <sub>ra</sub>	38	70		μA
Absolute spectral sensitivity	V <sub>R</sub> = 5 V, λ = 950 nm	s(λ)		0.55		A/W
Angle of half sensitivity		φ		± 20		deg
Wavelength of peak sensitivity		$\lambda_{p}$		920		nm
Range of spectral bandwidth		λ <sub>0.1</sub>		380 to 1100		nm
Quantum efficiency	λ = 950 nm	η		72		%
Noise equivalent power	$V_R = 20 \text{ V}, \lambda = 950 \text{ nm}$	NEP		3 x 10 <sup>-14</sup>		W/√Hz
Detectivity	$V_R = 20 \text{ V}, \lambda = 950 \text{ nm}$	D		3 x 10 <sup>12</sup>		cm√Hz/V
Rise time	$V_R = 50 \text{ V}, R_L = 50 \Omega, \lambda = 820 \text{ nm}$	t <sub>r</sub>		2.5		ns
Fall time	$V_{R} = 50 \text{ V}, R_{L} = 50 \Omega, \lambda = 820 \text{ nm}$	t <sub>f</sub>		2.5		ns

### **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

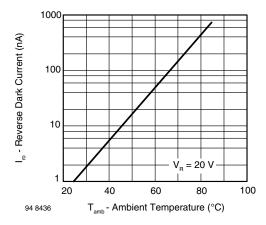


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

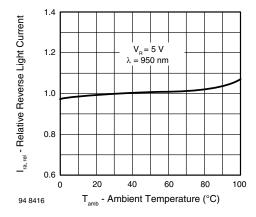


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature



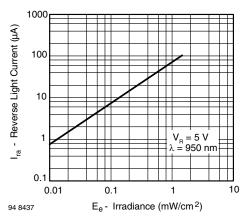


Fig. 3 - Reverse Light Current vs. Irradiance

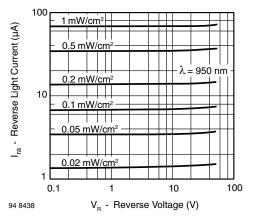


Fig. 4 - Reverse Light Current vs. Reverse Voltage

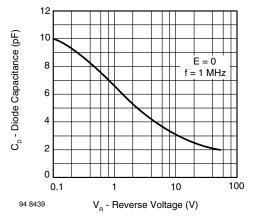


Fig. 5 - Diode Capacitance vs. Reverse Voltage

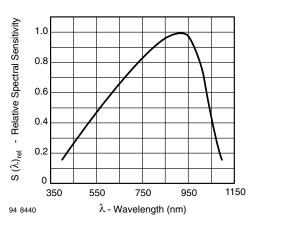


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

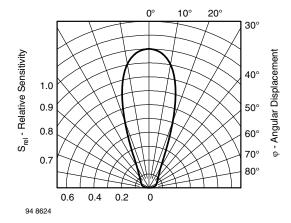
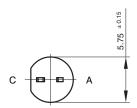
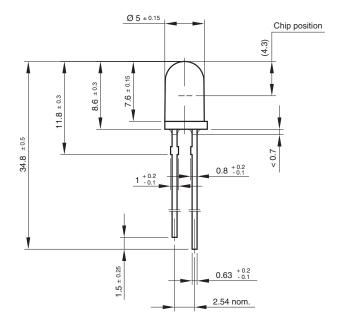


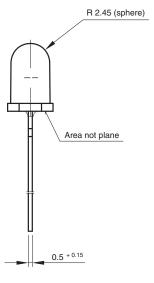
Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement



### **PACKAGE DIMENSIONS** in millimeters







technical drawings

according to DIN specifications

Drawing-No.: 6.544-5185.02-4

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